

Negative Fixed 12V Voltage Regulator in bare die form

Rev 1.0 23/07/25

Description

79L12 12V fixed 3-terminal negative voltage regulator delivers up to 100mA output current & is equipped with internal limiting + thermal shutdown features for overload immunity. Implementing this device at point-of-source removes the complexity of single point regulation methods + reduces noise. In replacement of a Zener diode/resistor combination, the device improves output impedance by x2 order of magnitude and delivers lower bias current with lower noise. The 79L12 can also be used with power-pass elements to make high-current voltage regulators.

Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-883 /2010B Visual Inspection
- "H" MIL-STD-883 /2010B Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-883 /2010A Visual Inspection (Space)
 + MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

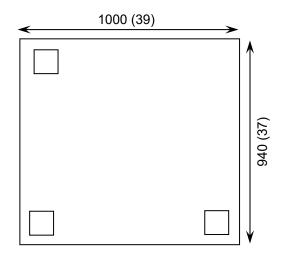
Supply Formats:

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape On request
- Unsawn Wafer On request
- With Ti/Ni/Ag Back Metal On request
- In Metal or Ceramic package On request

Features:

- ±5% V_{OUT} tolerance
- 100mA Output Current
- Internal thermal overload protection
- Internal short circuit current limit
- Full Military Temperature Range
- Positive Voltage complement is 78L12

Die Dimensions in µm (mils)



Mechanical Specification

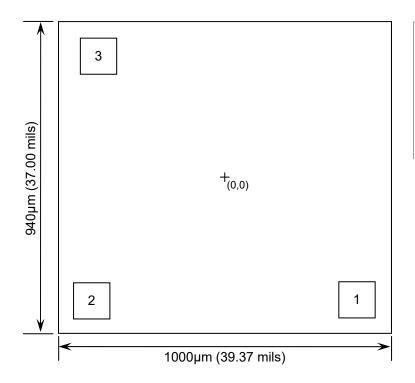
Die Size (Unsawn)	1000 x 940 39 x 37	µm mils	
Minimum Bond Pad Size	110 x 110 4.33 x 4.33	μm mils	
Die Thickness	280 (±20) 11 (±0.8)	μm mils	
Top Metal Composition	Al-Si-Cu 3μm		
Back Metal Composition	N/A – Bare Si		





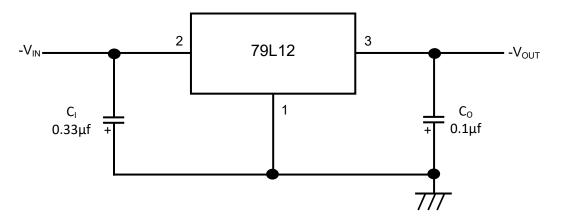
Rev 1.0 23/07/25

Pad Layout and Functions



PAD FUNCTION	COORDINATES (µm)			
	X	Y		
1	GND	395	-363	
2	-V _{IN}	-398	-369	
3	-V _{OUT}	-383	369	
CONNECT CHIP BACK TO -VIN				

Typical Application



 C_l is required if the regulator is located an appreciable distance from power supply filter. C_0 is not required for stability; however it does improve transient response. For optimum stability and transient response locate C_l C_0 as close as possible to the regulator.





Rev 1.0 23/07/25

Absolute Maximum Ratings

PARAMETER	SYMBOL	VALUE	UNIT
Input Voltage	V _{IN}	-35	V
Power Dissipation ¹	P _D	625	mW
Operating Temperature Range	-	-55 to 125	°C
Maximum Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-65 to 150	°C

Recommended Operating Conditions

PARAMETER	SYMBOL	MIN	MAX	UNIT
Input Voltage	V _{IN}	-14.5	-27	V
Output Current	I _{OUT}	-	100	mA
Operating Temperature Range	T _J	-55	125	°C

DC Electrical Characteristics V_{i} = -19V, I_{OUT} = 40mA, C_{i} = 0.33 μ F, C_{O} = 0.1 μ f, 0°C < T $_{J}$ < +125°C (unless noted otherwise)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
Output Voltage	V _{OUT}	$T_J = 25^{\circ}\text{C}, I_O = 40\text{mA}$	-11.52	12	-12.48	V	
		1mA≤ I _{OUT} ≤40mA,-14.5V ≥V _{IN} ≥ -27V	-11.40	-	-12.60		
		$1\text{mA} \le I_{\text{OUT}} \le 70\text{mA}, V_{\text{IN}} = -19V$	-11.40	-	-12.60		
Line Regulation ΔV _{out}	۸۱/	-14.5V≥V _{IN} ≥-27V,T _J =25°C,I _O =40mA	-	36	250	mV	
	ΔVOUT	-16V ≥V _{IN} ≥ -27V,T _J = 25°C, I _O =40mA	-	-	200		
Load Regulation	ΔV _{OUT}	$1\text{mA} \le I_{\text{OUT}} \le 100\text{mA}, T_{\text{J}} = 25^{\circ}\text{C}$	-	16	100		
		$1\text{mA} \le I_{\text{OUT}} \le 40\text{mA}, T_{\text{J}} = 25^{\circ}\text{C}$	-	-	50		
Input Bias Current	l _Β	T _J = 25°C	-	3.5	6.5	mA	
		T _J = 125°C	-	-	6.0	ША	
Input Bias Current	Input Bias Current	-16V ≥ V _{IN} ≥ -27V	-	-	1.5	mΛ	
Change ΔI _B	ΔIB	1mA ≤ I _{OUT} ≤ 40mA	-	-	0.1	mA	
Output Noise Voltage	e _N	10Hz ≤ f ≤ 100KHz, T _J = 25°C	-	210	-	μV_{RMS}	
Ripple Rejection	RR	$f = 120Hz, -15V \ge V_{IN} \ge 25V, T_J = 25^{\circ}C$	37	64	-	dB	
Dropout Voltage	V_D	$V_{IN} - V_{OUT}$	-	1.7	-	V	

^{1.} Value measured in TO-92 package applicable only for DC power dissipation permitted by absolute maximum ratings. Results in die form are dependent on die attach and assembly method.





Rev 1.0 23/07/25

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